

SANYO Semiconductors DATA SHEET

2SK3979 — General-Purpose Switching Device Applications

Features

- · Low ON-resistance.
- · Ultrahigh-speed switching.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		200	V
Gate-to-Source Voltage	VGSS		±30	V
Drain Current (DC)	ID		6	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	24	Α
Allowable Power Dissipation	D-		1	W
	PD	Tc=25°C	20	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Linit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	I _D =1mA, V _{GS} =0V	200			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =200V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	VGS=±24V, VDS=0V			±1	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	2.0		3.2	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =3A	2.1	3.5		S
Static Drain-to-Source On-State Resistance	RDS(on)	ID=3A, VGS=10V		320	450	mΩ
Input Capacitance	Ciss	V _{DS} =20V, f=1MHz		1090		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		85		pF
Reverse Transfer Capacitance	Crss	V _{DS} =20V, f=1MHz		35		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		17.5		ns
Rise Time	t _r	See specified Test Circuit.		26		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		50		ns
Fall Time	tf	See specified Test Circuit.		42		ns

Marking: K3979 Continued on next page.

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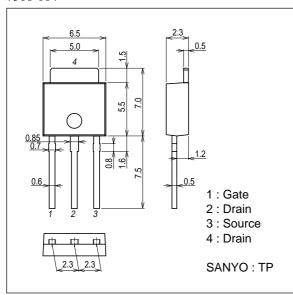
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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Total Gate Charge	Qg	V _{DS} =100V, V _{GS} =10V, I _D =6A		18.2		nC
Gate-to-Source Charge	Qgs	V _{DS} =100V, V _{GS} =10V, I _D =6A		8.0		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =100V, V _{GS} =10V, I _D =6A		7.0		nC
Diode Forward Voltage	VSD	IS=6A, VGS=0V		0.86	1.2	V

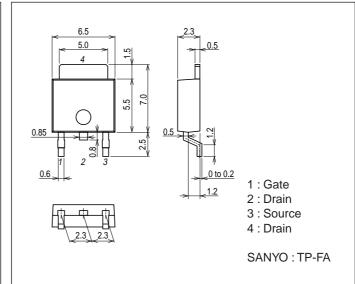
Package Dimensions

unit : mm 7518-004

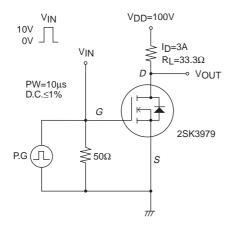


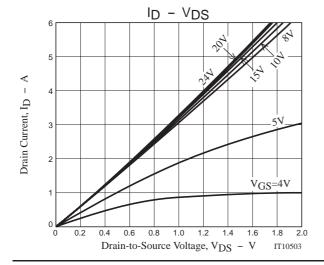
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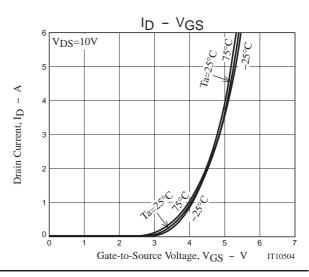
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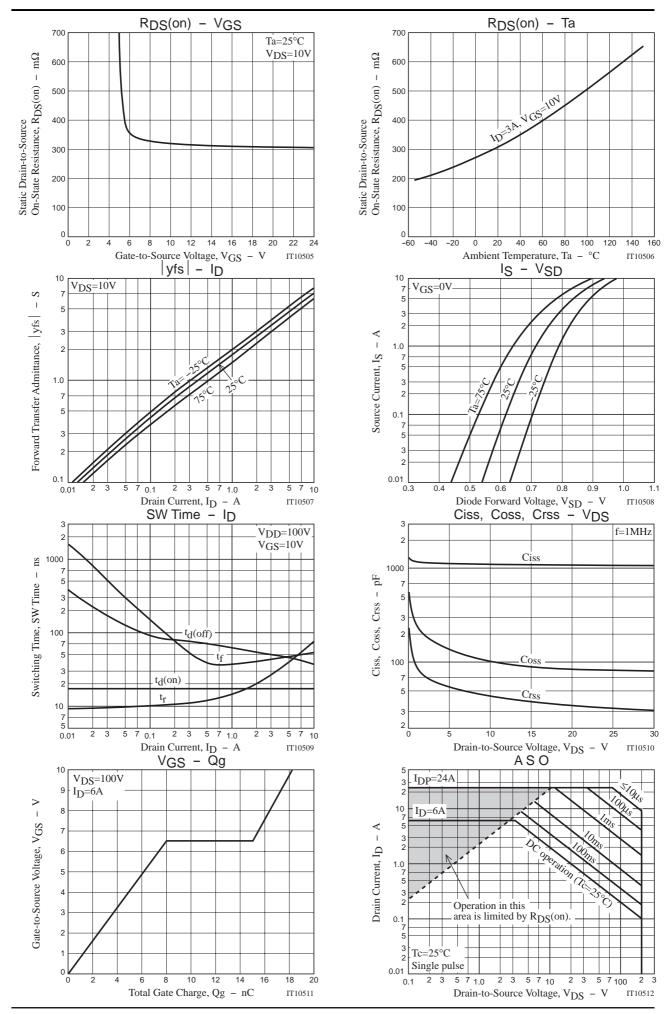


Switching Time Test Circuit

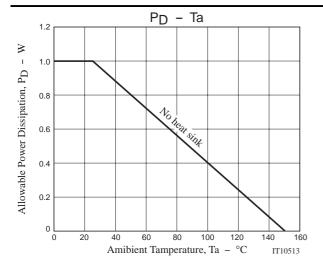


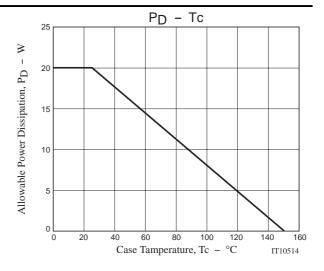






2SK3979





Note on usage: Since the 2SK3979 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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